

## Chengdu Kingbri Frequency Technology Co., Ltd



# PRODUCT APPROVAL SHEET

Product Type	XTB-TF-26 Tuning Fork Crystal Units
CREC's P/N	01.X.TB.108HRRI0000032768
Description	Tuning Fork XTB-TF-26 32.768KHz 8pF ±10ppm 50Kohm
Customer Number	LBY001
Customer P/N	-
Customer Name	-
Vevision	В0
Spec No.	LBY001XTB002

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Test					
Web Site	www.chinacrec.com				





XTB-TF-26 Tuning Fork Crystal Units

## **REVISION RECORD**

No	HISTORY	REASON	DATE
1	New	-	2023/7/28

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### 1 Parts explanation

The 32.768kHz turning fork crystal unit is the most widely used frequency control product. Its have low power consumption ideal for portable application. the different package sizes provide the customers more choices for time management.

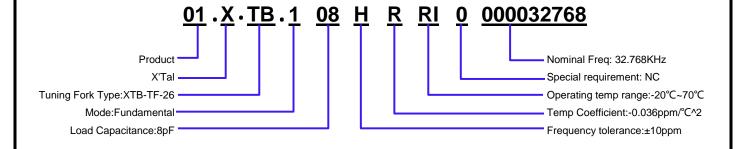
#### 2 SCOPE

This specification only covers CREC's 01.X.TB.108HRRI0000032768

#### 3 Reference Standard

- 3.1 MIL-STD-883H :Environmental tests' Mechanical tests.
- 3.2 MIL-STD-202: Test Methods for Electronic and Electrical component part.
- 3.3 IEC 60068-2 :Environmental tests' Mechanical tests.
- 3.4 ANSI/EIA-481-C: 8mm through 200mm enbossed carrier taping and 24mm punched
- 3.5 JEDEC J-STD-020C: Soldering

#### 4 Title Guide



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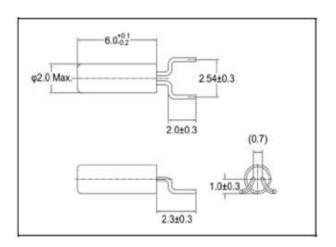
### 5 Performance

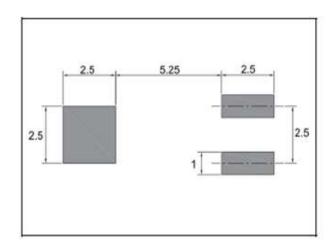
Electrical Performance. Electrical characteristics measured by S&A250B.

No.	Itama	Cumph		Electrical Specification			
INO.	Item	Symb.	Min.	Туре	Max.	Unit	(Humidity: 40%~60%)
1	Nominal Frequency	F0		32.768000		KHz	-
2	Frequency tolerance	ΔF/F0	-10	-	10	ppm	<b>25℃±3℃</b>
3	Operating Temperature Range	T <sub>OPR</sub>	-20	-	70	°C	-
4	Storage Temperature	Tstg	-40	-	85	°C	-
5	Turnover Temperature	TM	20	25	30	°C	-
6	Temperature Coefficient	β	-	-0.036	-	ppm/℃²	-
7	Frequency vs. Temperature	△f / fM		β*(T-TM)^2		ppm	-
8	Load Capacitance	CL	-	8	-	pF	-
9	Equivalent Series Resistance	ESR	-	-	50	Kohm	25°C±3°C
10	Drive Level	DL	-	-	1	μW	25°C±3°C
11	Insulation Resistance	IR	500	-	-	Mohm	@DC100V
12	Aging	Year	-5	-	5	ppm	First Year
13	Quality Factor	Q	-	50000	-	-	-
14	Shunt Capacitance	C0	-	1.75	•	pF	25℃±3℃
15	Motional Capacitance	C1	- 0.0035		-	pF	25°C±3°C
16	Capacitance Ratio	C0/C1	-	500	-	-	25℃±3℃

### 6 Figure

6.1 Product Dimensions and Solder Pad Layout Dimensions (Unit:mm) Product Dimensions





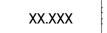
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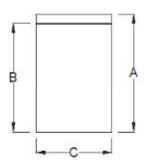
### 6.2 Marking

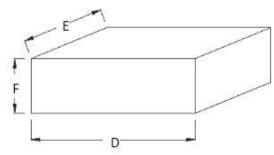


No.		Item		Remark
1	XX.XXX Nominal Frequency (MHz) 6digit		32.768	32.768=32.768KHz

### 7 Packing specification

### 7.1 Self-sealing plastic bag and Inner Box



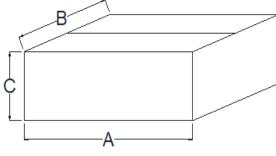


Self-sealing plastic bag

Inner Box

Item	Self-sealing plastic bag				Inner Box		
пеш	А	В	С	D	Е	F	
Spec(mm)	125	115	84	184	126	58	
Tol.(mm)	±0.50	±0.50	50 ±0.50		-	-	
Q'ty (pcs)	1K/Bull Max			10K	/Box	Max	

### 7.2 Carton



Item	Α	В	С
SPEC(mm)	410	350	150
Q'ty (pcs)	100K/Carton Max		

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## 8 Reliability Test Item

No.	Item	Test Condition	Reference
1	Drop Test	Hight: 50cm Times: 2 times on hardWood	IEC68-2-32 Free Fall
2	Vibration	Frequency: 20 to2000Hz, full wave Amplitude: 1.5 mm (Peak to Peak) Sweep/Cycle: 2 minutes Accelerated Speed: 20g Direction: X, Y,Z Duration: 4min ,4 times in each direction	IEC68-2-6 Vibration
3	Solderability	Temperature: 235±5℃ Time: 10±1 Sec	MIL-STD-202 Method 210B Condition B
4	Aging	Temperature: 100°C Time:168 hours	MIL-STD-883H Method 1008.2
5	Fine Leak	Helium Bombing:0.4~0.5Mpa Time:1 hour	MIL-STD-883H METHOD 1014.13
6	High Temperature Storage	Temperature: $85^{\circ}$ C ± $5^{\circ}$ C Time 96 hours	IEC 60068-2-2
7	Temperature Cycle	Conditions: $25\% \pm 3\%$ for 10 minutes $-40\% \pm 3\%$ for 30 minutes $25\% \pm 3\%$ for 10 minutes $125\% \pm 3\%$ for 30 minutes $100$ cycles	MIL-STD-883H METHOD 1010.8
8	Resistance to Soldering Heat	Pre-Heating:125°C 60~120 Sec Solder temperature: 260± 5°C Time: 20±5 sec	MIL-STD-202 Method 210B Condition B
9	Humidity	Temperature: $60^{\circ}C \pm 2^{\circ}C$ Relative Humidity: 95% Time: 96 hours.	IEC 60068-2-3 Damp Heat
10	Thermal shock	-40 °C ± 3 °C to 100 °C ± 3 °C, soak 15 minutes at each point, transfer time within 15 seconds, 20 cycles.	MIL-STD-883H METHOD 1011.9
11	Low Temperature Storage	Temperature: $-40^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Time: 96 hours	IEC 60068-2-1
12	Salt Spray	Temperature: 35±2℃ Salinity: 5% Time:24hrs	MIL-STD-883H Method 1009.8 Condition A

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#### 9 Product handling and control procedure

#### 9.1 Precautions for storage

Storage of crystal units under higher temperature or high humidity for a long term may affects frequency stability or solderability. Please store the crystal units under the normal temperature and humidity without exposing to direct sunlight and dew condensation, and avoid the storage of crystal units for more than 6 months, and mount them as soon as possible after unpacking.

Item		Electrical Specification			
		Min.	Туре	Max.	Unit
Storage peiod	After customer assembly	15		-	Year
	Crystal unused	-		2	Year

#### 9.2 Mounting of SMD Type products

When using an automatic loading machine, please test and confirm to cause no damage to the crystal units before mounting. Bending the circuit board in the process of cleaving boards after mounting and soldering crystal units may cause peeling off the soldering or package cracks by mechanical stress.

#### 9.3 Ultrasonic cleaning

General cleaning solutions or ultrasonic cleaning method may be used to clean CREC's products. However, under certain circumstances, ultrasonic cleaning machine could generate resonance at the oscillaton frequency of our products and thus deteriorate the electrical characteristics in devices, and even damage the overall structure of devices. Therefore, verification test is recommended before cleaning.

#### 9.4 Ultrasonic welding

Avoid mounting and processing by Ultrasonic welding this method has a possibility of an excessive vibration spreading inside the crystal products and becoming the cause of characteristic deterioration and not oscillating. If Ultrasonic welding is being used in process, please notify us in advance to verify it.

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